TOSHIBA Field Effect Transistor Silicon N Channel Junction Type

2SK30ATM

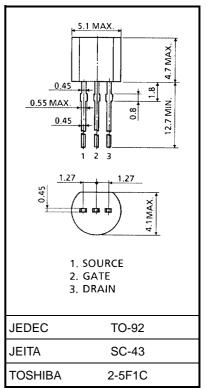
Low Noise Pre-Amplifier, Tone Control Amplifier and DC-AC High Input Impedance Amplifier Circuit Applications

- High breakdown voltage: $V_{GDS} = -50 V$
- High input impedance: $I_{GSS} = -1 \text{ nA} (max) (V_{GS} = -30 \text{ V})$
- Low noise: NF = 0.5dB (typ.)

 $(V_{DS} = 15 \text{ V}, V_{GS} = 0, R_G = 100 \text{ k}\Omega, f = 120 \text{ Hz})$

Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Gate-drain voltage	V _{GDS}	-50	V
Gate current	IG	10	mA
Drain power dissipation	PD	100	mW
Junction temperature	Тј	125	°C
Storage temperature range	T _{stg}	-55~125	°C



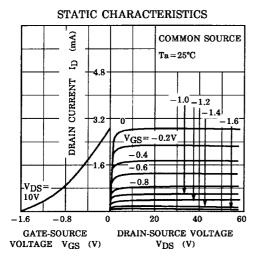
Weight: 0.21 g (typ.)

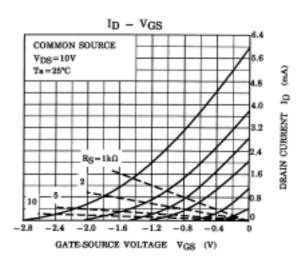
Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate cut-off current	I _{GSS}	$V_{GS}=-30~V,~V_{DS}=0$	_	_	-1.0	nA
Gate-drain breakdown voltage	V (BR) GDS	$V_{DS} = 0, I_G = -100 \ \mu A$	-50	_	_	V
Drain current	I _{DSS} (Note)	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0$	0.3	_	6.5	mA
Gate-source cut-off voltage	V _{GS (OFF)}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 0.1 \mu\text{A}$	-0.4	_	-5.0	V
Forward transfer admittance	Y _{fs}	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0, \text{ f} = 1 \text{ kHz}$	1.2	_	_	mS
Input capacitance	C _{iss}	$V_{GS} = 0, V_{DS} = 0, f = 1 \text{ MHz}$	_	8.2	_	pF
Reverse transfer capacitance	C _{rss}	$V_{GD} = -10 \text{ V}, \text{ V}_{DS} = 0, \text{ f} = 1 \text{ MHz}$		2.6		pF
Noise figure	NF	$V_{DS} = 15 \text{ V}, V_{GS} = 0$ $R_G = 100 \text{ k}\Omega, \text{ f} = 120 \text{ Hz}$	_	0.5	5.0	dB

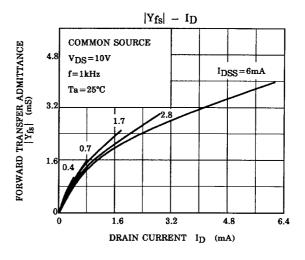
Note: IDSS classification R: 0.30~0.75, O: 0.60~1.40, Y: 1.20~3.00, GR: 2.60~6.50

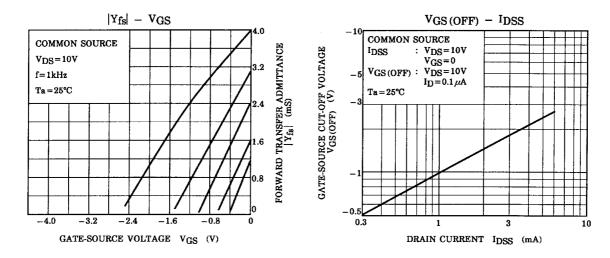
Unit: mm



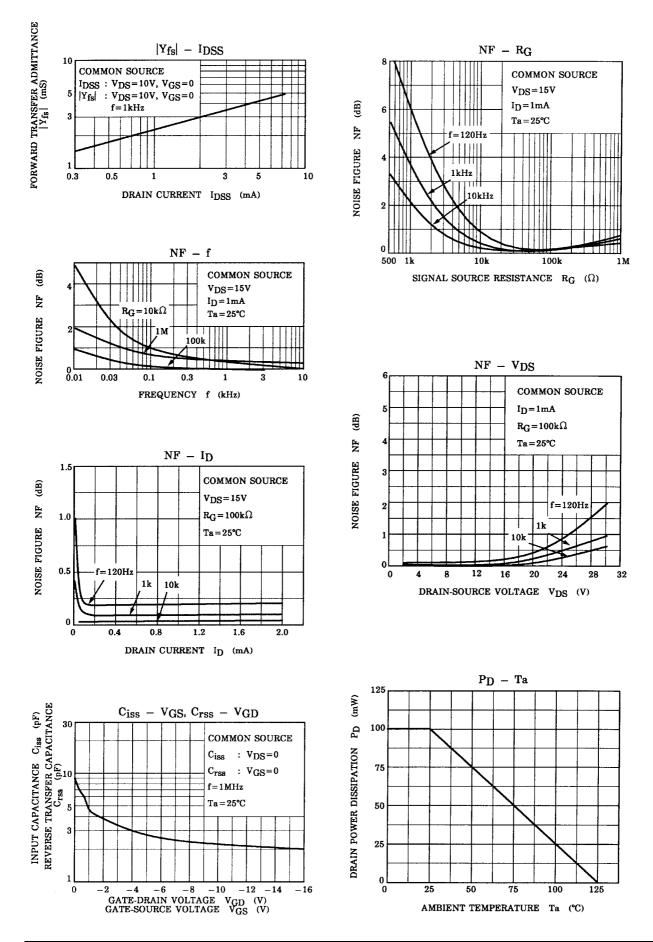


ID - VDS (LOW VOLTAGE REGION) 3.2 COMMON SOURCE 0 $Ta = 25^{\circ}C$ (WW) 2.4 0.27 VGS <u>9</u> DRAIN CURRENT -0.4 1.6 -0.6 -1.4 1.0 -0.8 -1.6 -1.20.8 0 0.8 1.6 2,4 3.2 4.0 0 DRAIN-SOURCE VOLTAGE V_{DS} (V)





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